

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYEJUNG HUR	10/06/2020
SEJIN OH	10/06/2020
RECEIVING PARTY DATA	
Name:	LG ELECTRONICS INC.
Street Address:	128 YEOUI-DAERO, YEOUNGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17062991
CORRESPONDENCE DATA	
Fax Number: <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-496-7500
Email:	mlapto@dentons.com
Correspondent Name:	DENTONS US LLP
Address Line 1:	1900 K STREET, NW
Address Line 4:	WASHINGTON, D.C. 20006
ATTORNEY DOCKET NUMBER:	8737.02745.US00
NAME OF SUBMITTER:	MARK R. KRESLOFF
SIGNATURE:	/Mark R. Kresloff/
DATE SIGNED:	10/07/2020
Total Attachments: 2 source=ASSIGNMENT#page1.tif source=ASSIGNMENT#page2.tif	

ASSIGNMENT

For valuable consideration, the receipt of which we acknowledge, and intending to be bound legally, we, **Hyejung HUR, Sejin OH**, each individually assign to **LG Electronics Inc.**, a corporation formed under the laws of **Republic of Korea**, and having a principal place of business at **128, Yeoui-daero, Yeongdeungpo-gu, Seoul 07336 Republic of Korea**, and its successors, transferees, and assignees (collectively the "Assignee"), all of our individual and joint right, title, and interest throughout the world in the subject matter (the "Subject Matter") of a patent application that names us as inventors, is titled "**POINT CLOUD DATA TRANSMISSION DEVICE, POINT CLOUD DATA TRANSMISSION METHOD, POINT CLOUD DATA RECEPTION DEVICE, AND POINT CLOUD DATA RECEPTION METHOD**," and was filed in the United States Patent and Trademark Office on October 5, 2020, as application 17/062,991 (the "Application"). We authorize the insertion of the filing date and application number above.

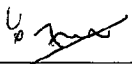
This Assignment assigns (a) the Application and all other applications that may be made for, and all patents, utility models, design registrations, and other rights of exclusion and inventors' certificates for, any of the Subject Matter (collectively the "Applications and Granted Rights") in every country or region, (b) the right to claim priority based on and the benefit of the filing date of any of the Applications and Granted Rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other applicable treaties or conventions, and (c) the right to pursue, collect, and retain in the Assignee's name or otherwise, damages and any other remedies arising from any past, present, or future infringement of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment.

We authorize the Assignee to apply for and pursue protection for any or all of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment in all countries, regions, and territories of the world, in our names or in the Assignee's name.

We represent and warrant that we have the right and power to make this Assignment and that we have not made and will not make any other assignment that conflicts with this Assignment.


We will communicate to the Assignee (or at the request of the Assignee to other parties) all known facts in any form relating to the Subject Matter, will execute and provide all oaths and declarations, statements, testimony, assignments, powers of attorney, applications, and documents,

and will perform all other lawful acts necessary or desirable to secure fully to the Assignee the rights, titles, and interests assigned by this Assignment.



Hyejung HUR

Date: Oct. 6, 2020



Sejin OH

Date: Oct. 6, 2020

The Assignee hereby acknowledges and accepts the foregoing assignment.

Assignee: LG ELECTRONICS INC.

Signature: _____ Date: _____

Name: _____

Title: _____

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